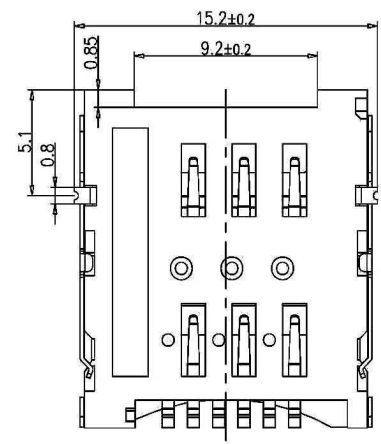
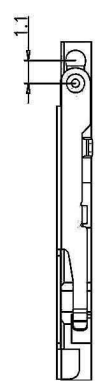
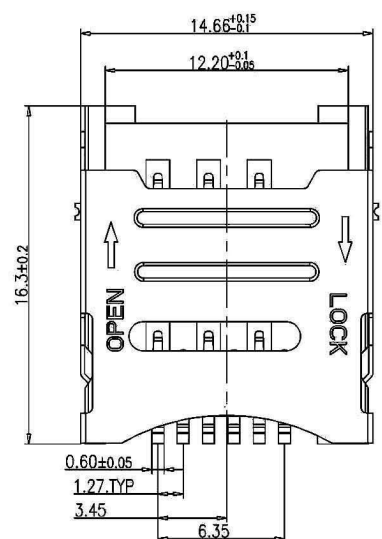


1 2 3 4 5 6 7 8

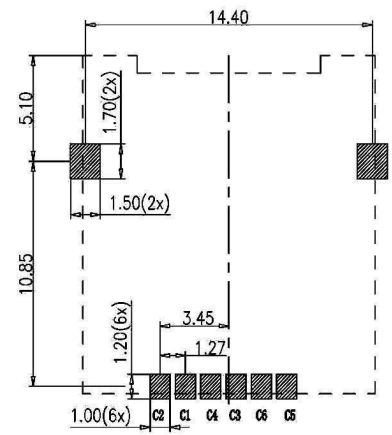
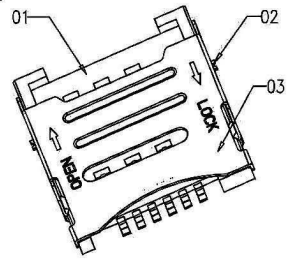
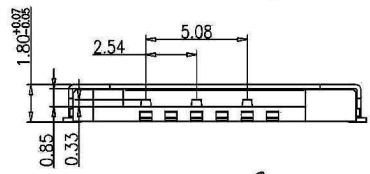
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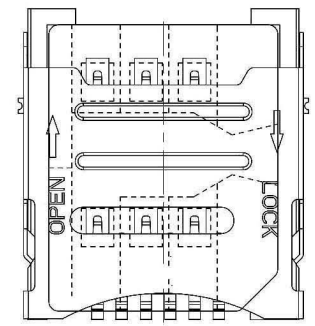
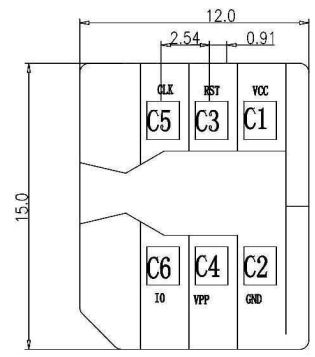


NOTE:

- 1.MATERIAL:
  - A. HOUSING: LCP, UL 94-V0 COLOR: BLACK
  - B.CONTACT: PHOSPHOR BRONZE, C5210H, T=0.15
  - C.SHELL: STAINLESS STEEL, T=0.2
2. PLATING: NICKEL UNDERPLATED,AND CONTACT AREA: AU PLATED
- 3.ELECTRONICAL CHARACTERISTICS:
  - A. CURRENT VOLTAGE: 30V Max (DC)
  - B. CURRENT RATING: 1AMP MAX
  - C. OPERATING TEMPERATURE:-40°C~+85°C
  - D. INSULATION RESISTANCE:1000M OHMME MIN.(500DC)
  - E. DIELECTRIC WITHSTANDING VOLTAGE: 500 VAC/1MINUTE
  - F. CONTACT RESISTANCE: 30 OHMME MAX
  - G. LIFE: >3000 CYCLE



PCB LAYOUT



MICRO SIM

PIN NO.	NAME	PIN NO.	NAME
C1	VCC	C4	VPP
C2	GND	C5	CLK
C3	RST	C6	IO

RoHS Compliant		<b>HSM</b> 玄茂科技股份有限公司 <b>HSUAN MAO TECHNOLOGY CO., LTD.</b>	
APPD. 核准 SCALE 比例 DWG. 製圖 DATE 制表日	Betty 104/01/28	GENERAL TOLERANCE X ±0.30 X ±1 X.X ±0.25 .X ±0.1 X.XX ±0.20 X.XXX ±0.10 UNIT 單位 M M PAGE 張數 1 OF 1 REV. 版次 B	PART NAME 品名 MICRO SIM CARD CONNECTOR HINGED TYPE 6PIN SMT TYPE H=1.8mm SELECTIVE GOLD PLATING BLACK COLOR REEL PACKING ROHS PART NO. 料號 C0636-06DASBR0R

1 2 3 4 5 6 7 8